

Description

This MOSFETs use advanced trench technology and design to provide excellent RDS(on) with low gate charge. It can be used in a wide variety of applications.

Features

BVDSS	ID
600V	1A

- 1) Low gate charge.
- 2) Green device available.
- 3) Advanced high cell density trench technology for ultra RDS(ON)
- 4) Excellent package for good heat dissipation.



TO-92

Absolute Maximum Ratings $T_c=25^\circ\text{C}$,unless otherwise noted

Thermal Characteristics

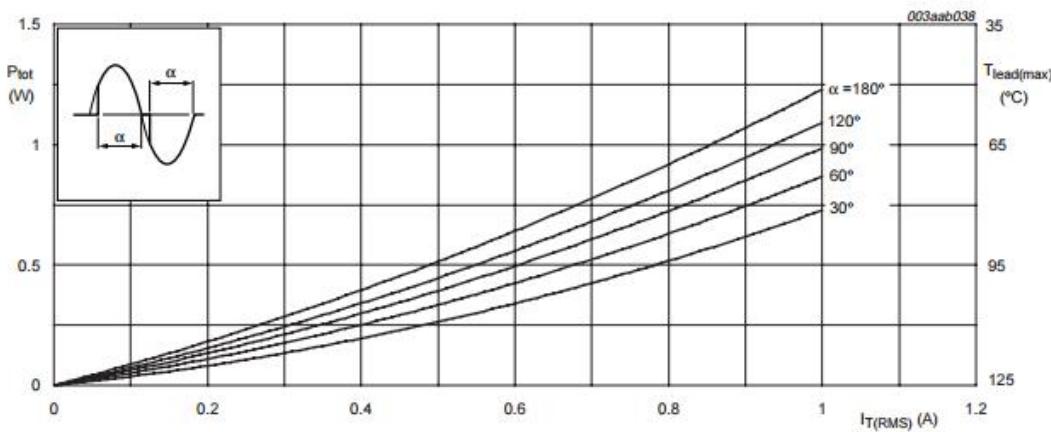
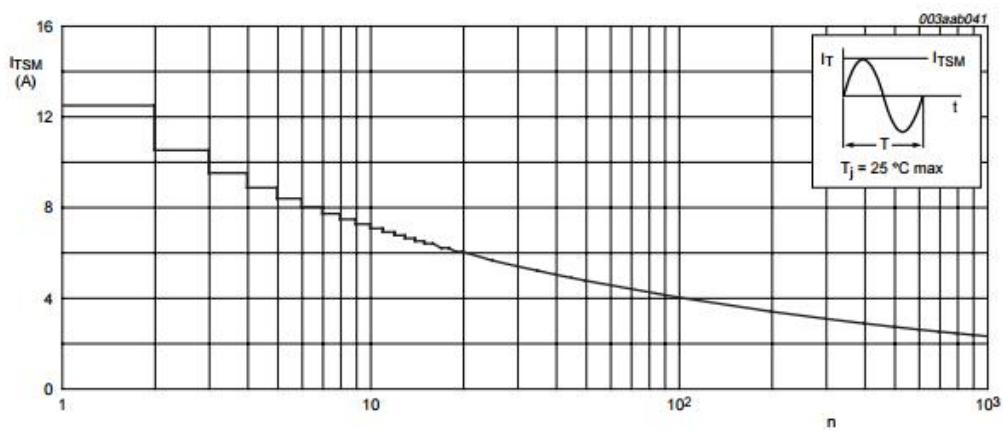
Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Thermal Resistance ,Junction to Case1	—	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient1	—	$^\circ\text{C}/\text{W}$

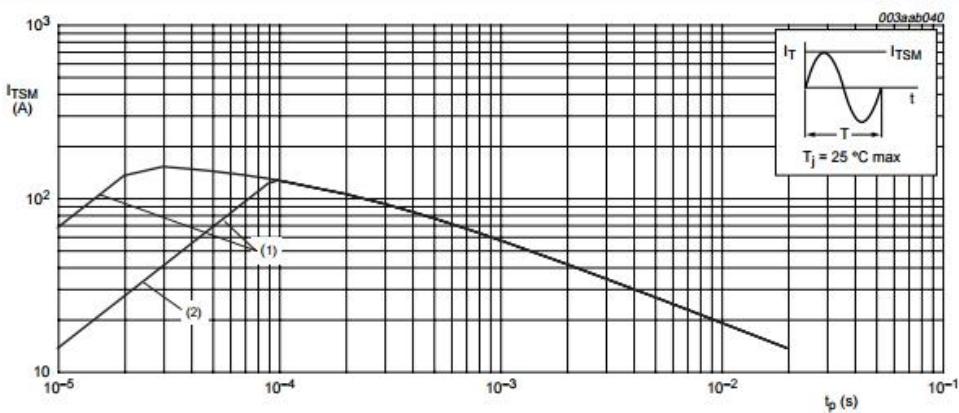
Package Marking and Ordering Information

Part NO.	Marking	Package
BT131-600E	BT131-600E	TO-92

$T_j = 25^\circ\text{C}$ unless otherwise stated.

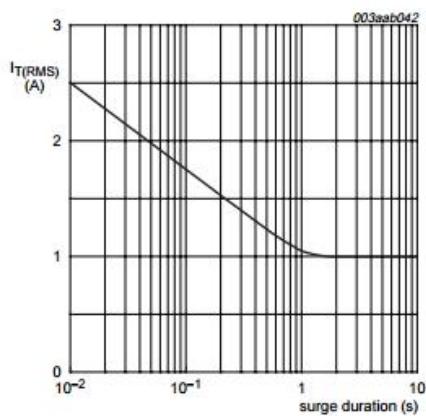
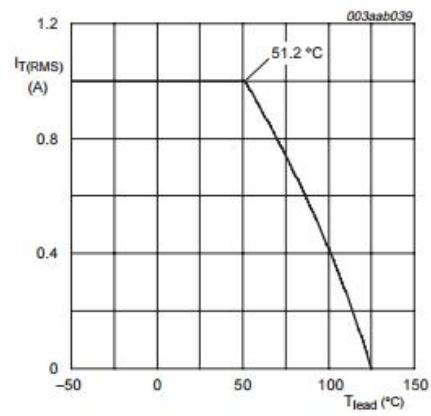
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
I_{GT}	gate trigger current	$V_D = 12 \text{ V}$; $I_T = 100 \text{ mA}$; see Figure 8				
		T2+ G+	-	0.4	3	mA
		T2+ G-	-	1.3	3	mA
		T2- G-	-	1.4	3	mA
		T2- G+	-	3.8	7	mA
I_L	latching current	$V_D = 12 \text{ V}$; $I_{GT} = 100 \text{ mA}$; see Figure 10				
		T2+ G+	-	1.2	5	mA
		T2+ G-	-	4	8	mA
		T2- G-	-	1	5	mA
		T2- G+	-	2.5	8	mA
I_H	holding current	$V_D = 12 \text{ V}$; $I_{GT} = 100 \text{ mA}$; see Figure 11	-	1.3	5	mA
V_T	on-state voltage	$I_T = 1.4 \text{ A}$; see Figure 9	-	1.2	1.5	V
V_{GT}	gate trigger voltage	$I_T = 10 \text{ mA}$; gate open circuit; see Figure 7				
		$V_D = 12 \text{ V}$; $I_{GT} = 100 \text{ mA}$	-	0.7	1.5	V
		$V_D = 400 \text{ V}$; $I_{GT} = 100 \text{ mA}$; $T_j = 125^\circ\text{C}$	0.2	0.3	-	V
I_D	off-state current	$V_D = V_{DRM(\max)}$; $T_j = 125^\circ\text{C}$	-	0.1	0.5	mA
Dynamic characteristics						
dV_D/dt	rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(\max)}$; $T_j = 125^\circ\text{C}$; exponential waveform; $R_{GK} = 1 \text{ k}\Omega$; see Figure 12	10	20	-	V/ μ s
dV_{com}/dt	rate of change of commutating current	$V_{DM} = 400 \text{ V}$; $T_j = 125^\circ\text{C}$; $dI_{com}/dt = 0.5 \text{ A/ms}$	2	-	-	V/ μ s
t_{gt}	gate-controlled turn-on time	$I_{TM} = 1.5 \text{ A}$; $V_D = V_{DRM(\max)}$; $I_G = 100 \text{ mA}$; $dI_G/dt = 5 \text{ A}/\mu\text{s}$	-	2	-	μ s

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Fig 1. Total power dissipation as a function of average on-state current; maximum values

Fig 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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 $t_p \leq 20 \text{ ms}$

(1) dI_T/dt limit

(2) T2-G+ quadrant

Fig 3. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

Fig 4. RMS on-state current as a function of surge duration, for sinusoidal currents; maximum values

Fig 5. RMS on-state current as a function of lead temperature; maximum values